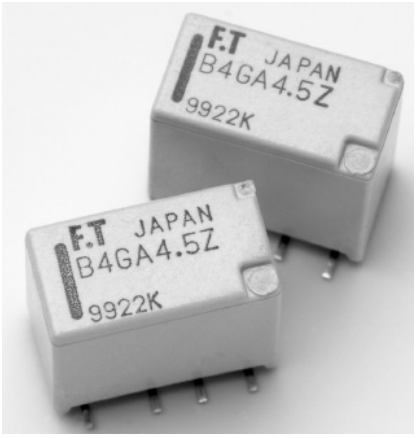
FUJITSU

ULTRA MINIATURE RELAY
2 POLES - 2 A (Slim Profile Signal Relay)
FTR-B4 Series

■ FEATURES



- DPDT 2C
- Ultra miniature slim type relay for surface mounting
  Height: 9.3 mm maximum (THT)
  10 mm maximum (SMT)
  Weight: Approximately 1.0 g
- Conforms to Bellcore & FCC part 68, and Telcordia & FCC part 68
- Conforms to UL1950 / CSA 950, IEC 950 / EN60950 spacing and high breakdown voltage
  Clearance: 1.0mm
  Creepage: 1.6mm
  Basic insulation, 150V working voltage, pollution degree 2
- High reliable birfuracted gold overlay silver contact
- Low power consumption 140 mW (standard), 100 mW (latching)
- RoHS compliant.
  Please see page 9 for more information

■ PARTNUMBER INFORMATION

	FTR-B4	C	A	4.5	Z	-	B	05
[Example]	(a)	(b)	(c)	(d)	(e)		(f)	(g)

(a)	Relay type	FTR-B4	: FTR-B4-Series
(b)	Terminal type	C G S	: Through hole : Surface mount : Surface mount, space saving
(c)	Coil type	A B	: Standard type : Latching type (1 coil)
(d)	Coil rated voltage	4.5	: 1.5.....24 VDC Coil rating table at page 3
(e)	Contact material	Z P	: Gold overlay silver nickel (standard) : Gold overlay silver palladium
(f)	Relay enclosing direction *1	B	: Standard enclosing direction
(g)	Number of relays per reel *2	05	: 500 (standard)

Remarks: Actual marking on relay would not carry code FTR and be as below:
Ordering code: FTR-B4CA4.5Z Actual marking: B4CA4.5Z

*1 - Only surface mount types (G and S) are applicable
*2 - All relays are packaged in tubes unless part number ends with -B05

■ SPECIFICATION

Item			Standard type	Latching type
			FTR-B4 ( ) A	FTR-B4 ( ) B
Contact Data	Configuration		2 form C	
	Construction		Bifurcated contacts (cross-bar)	
	Material		Gold overlay silver nickel / Gold overlay silver palladium	
	Resistance (Initial)		Max. 100 mΩ at 1 A, 6 VDC	
	Contact rating (resistive)		30VDC, 1A / 125VAC, 0.3A	
	Max. carrying current		2A	
	Max. switching voltage		250 VAC / 220VDC	
	Max. switching power		62.5VA / 30W	
	Min. switching load *		0.01mA, 10mVDC	
Life	Mechanical		Min. 50 x 10^6 operations	Min. 20 x 10^6 operations
	Electrical	DC load	Min. 100 x 10^3 operations at 1A, 30VDC (at 0.5 Hz)	
		AC load	Min. 100 x 10^3 operations at 0.3A, 125VAC (at 0.5 Hz)	
Coil Data	Rated power		140mW - 230mW	100mW - 130mW
	Operate power		80mW - 130mW	57mW - 68mW
	Operating temperature range		-40 °C to +85 °C (no frost)	
Timing Data	Operate (at nominal voltage, no bounce)		Max. 3 ms	Max. 3 ms (set)
	Release (at nominal voltage, no bounce)		Max. 3 ms	Max. 3 ms (reset)
Insulation	Resistance (initial)		Min. 1,000MΩ at 500VDC	
	Dielectric strength	Open contacts	1,000VAC (50/60Hz) 1min	
		Contacts to coil	1,500VAC (50/60Hz) 1min	
		Adjacent contacts	1,000VAC (50/60Hz) 1min.	
	Surge strength	Coil to contacts	2,500V, 2 x 10μs standard wave	
	Clearance	Adjacent contacts	1.0 mm	
		Open contacts	0.28 mm	
		Coil and contacts	1.0 mm	
	Creepage	Adjacent contacts	1.0 mm	
		Open contacts	0.28 mm	
		Coil and contacts	1.60 mm	
Other	Vibration resistance	Misoperation	10 to 55 Hz at double amplitude of 3 mm	
		Endurance	10 to 55 Hz at double amplitude of 5 mm	
	Shock	Misoperation	750m/s²	
		Endurance	1,000m/s²	
	Weight		Approximately 1 g	

* Minimum switching loads mentioned above are reference values. Please perform the confirmation test with actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels.

■ COIL RATING

Standard type

Coil Code	Rated Coil Voltage (VDC)	Coil Resistance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Max. Coil Voltage (VDC)	Rated Power (mW)
1.5	1.5	16.1	1.13	0.15	3.53	140
003	3	64.3	2.25	0.3	7.05	
4.5	4.5	145	3.38	0.45	10.58	
006	6	257	4.5	0.6	14.10	
009	9	579	6.75	0.9	21.15	
012	12	1,028	9	1.2	28.20	
024	24	2,504	18	2.4	56.40	230

Latching type (1 coil)

Coil Code	Rated Coil Voltage (VDC)	Coil Resis-tance +/- 10% (Ohm)	Must Operate Voltage (VDC) *	Must Release Voltage (VDC) *	Max. Coil Voltage (VDC)	Set/Re-set current (mA)	Rated Power (mW)
1.5	1.5	22.5	1.13	-0.13	3.53	50	100
003	3	90	2.25	-2.25	7.05	25	
4.5	4.5	203	3.38	-3.38	10.58	17	
006	6	360	4.5	-4.5	14.10	13	
009	9	810	6.75	-6.75	21.15	8	
012	12	1,440	9	-9	28.20	6	
024	24	4,800	18	-18	56.40	4	120

Note: All values in the table are valid for 20°C and zero contact current.
* Specified operate values are valid for pulse wave voltage.

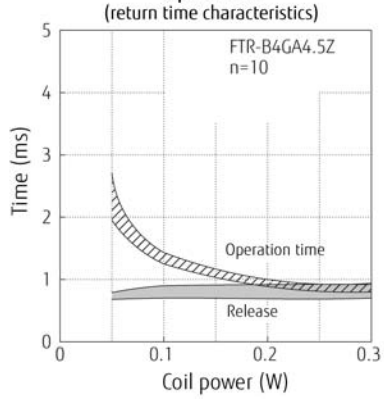
■ SAFETY STANDARDS

Type	Compliance	Contact rating
UL	UL 508 E 63615	Flammability: UL 94-V0 (plastics) 0.5A, 125VAC (resistive) 1A, 30VDC (resistive) 0.3A, 110VDC (resistive) 2A, 30VDC (resistive)
CSA	C22.2 No. 14 LR 40304	

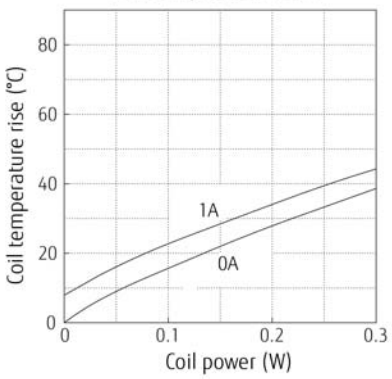
■ CHARACTERISTIC DATA

- **Standard type**

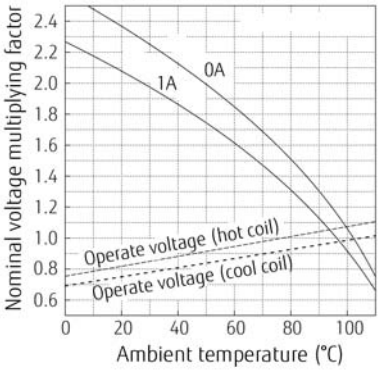
Operation
(return time characteristics)



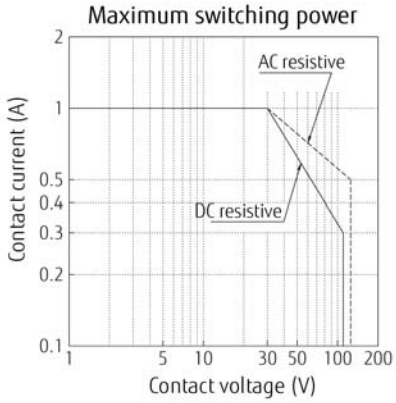
Coil temperature rise



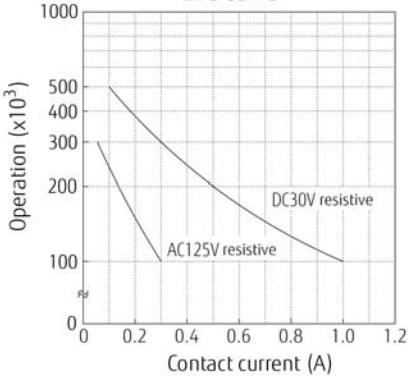
Ambient temperature



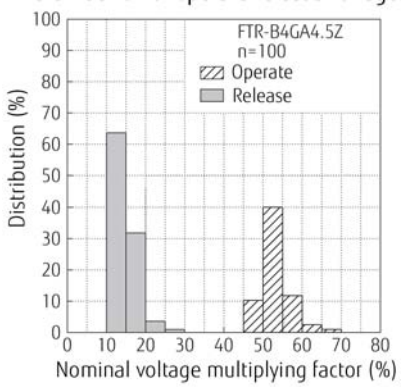
Maximum switching power



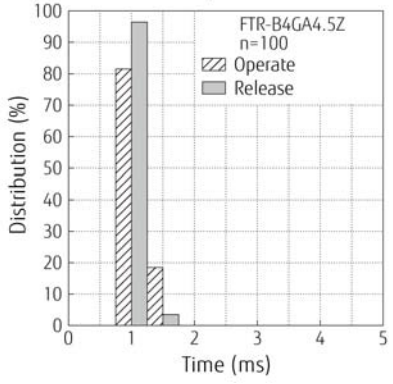
Life curve



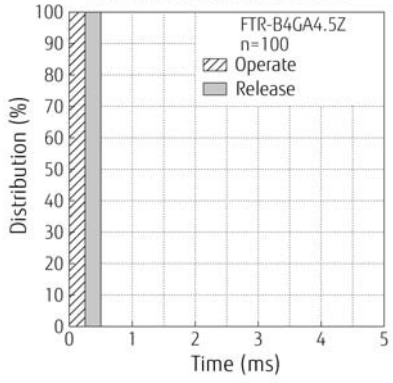
Distribution of operate/release voltage



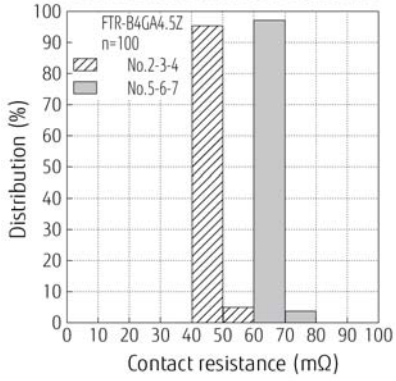
Distribution of operate/release time

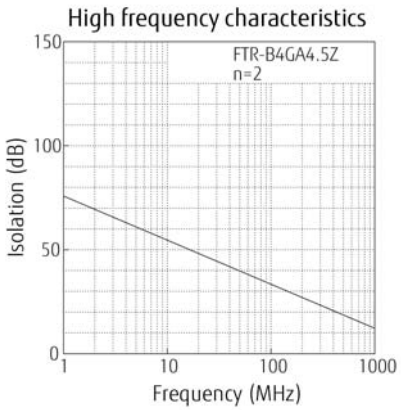


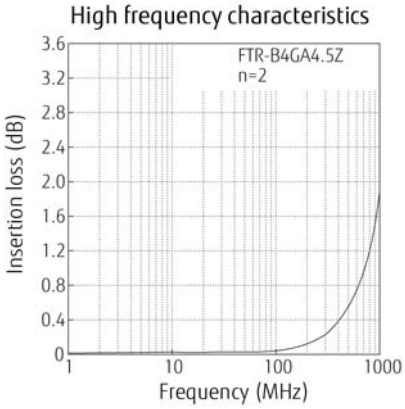
Distribution of bounce time



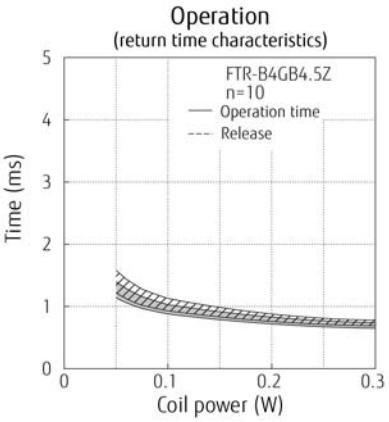
Distribution of contact resistance

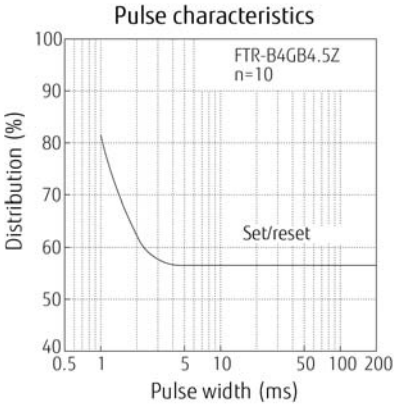


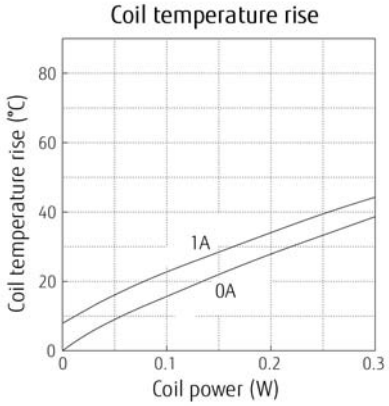


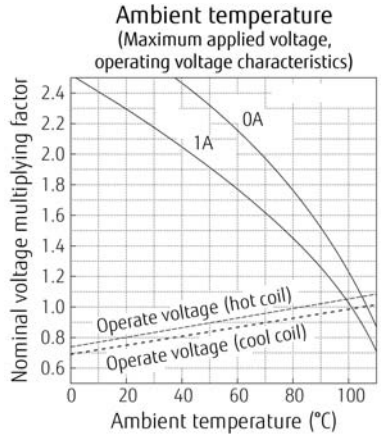


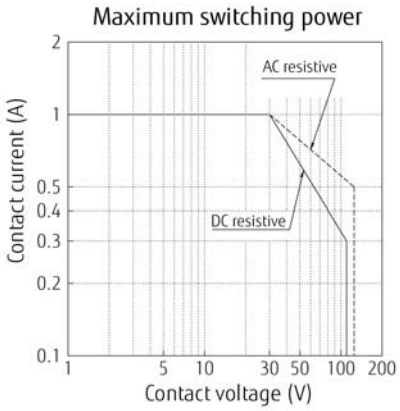
- **Latching type (1coil)**

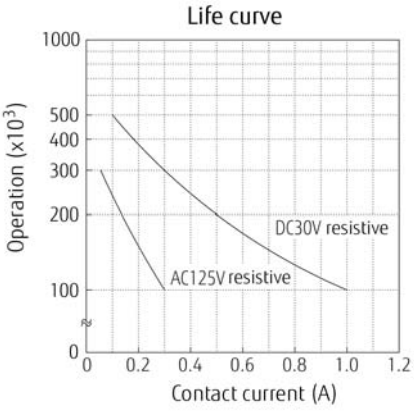


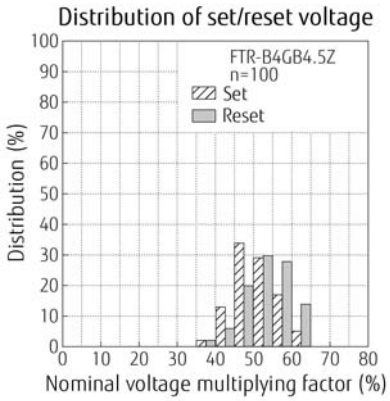


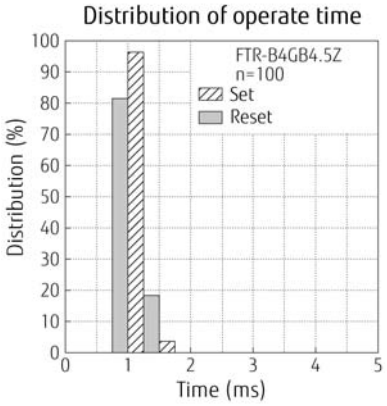


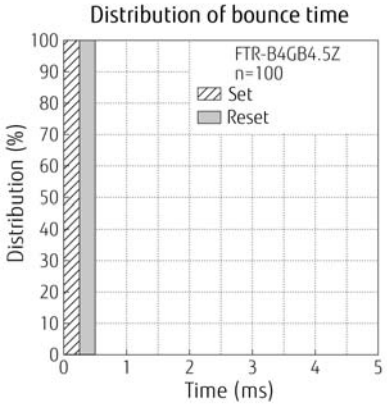


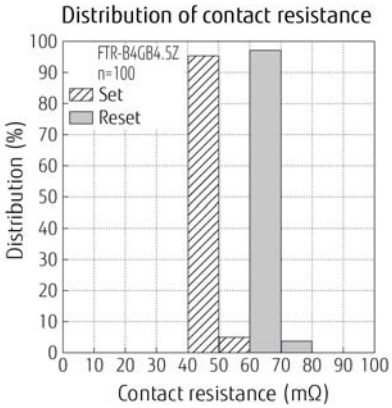


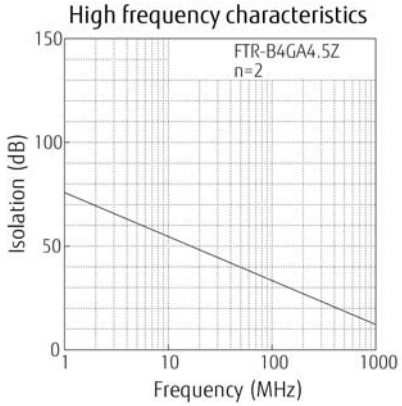


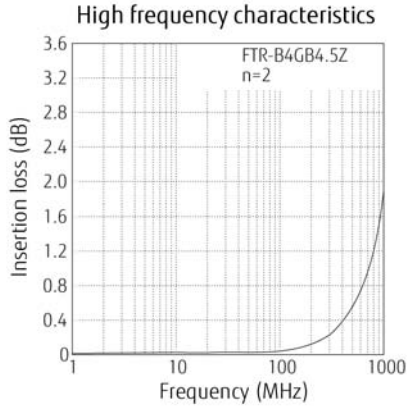








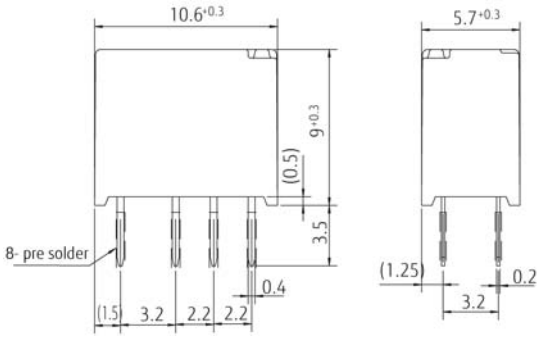




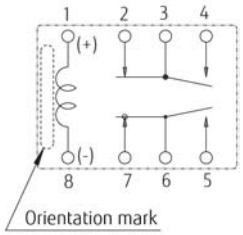
■ DIMENSIONS

FTR-B4C - Through hole type

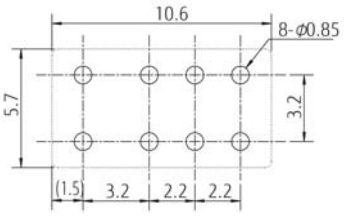
- **Dimensions**



- **Schematics** (BOTTOM VIEW)

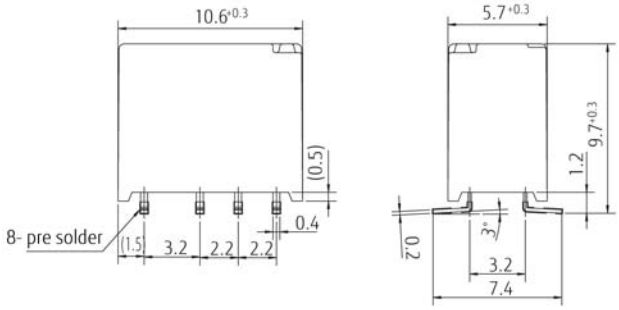


- **PC board mounting hole layout** (BOTTOM VIEW)

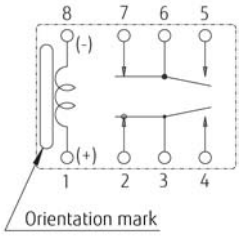


FTR-B4G - Surface mount type

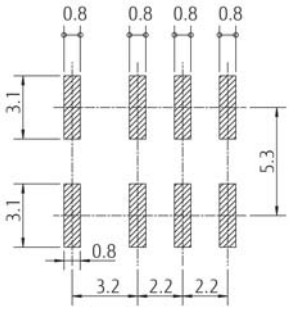
- **Dimensions**



- **Schematics** (TOP VIEW)

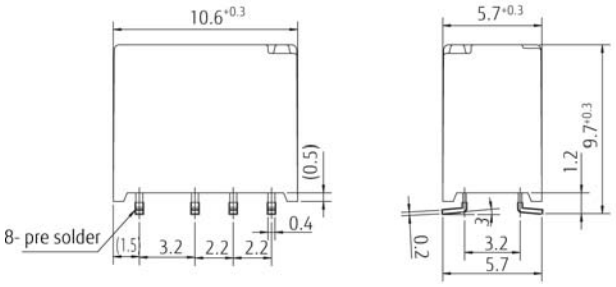


- **PC board mounting pad layout** (TOP VIEW)

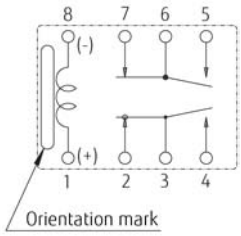


FTR-B4S- Space saving type

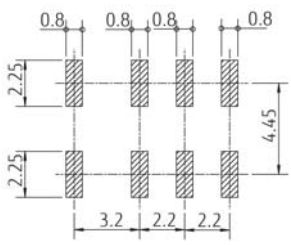
- **Dimensions**



- **Schematics** (TOP VIEW)



- **PC board mounting pad layout** (TOP VIEW)



* Indicates reset state for latching relays (FTR-B4CB, FTR-B4GB and FTR-B4SB versions)
Indicates non-operate state for standard relays (FTR-B4CA, FTR-B4GA and FTR-B4SA versions)

■ COIL POLARITY LATCHING TYPE

Coil terminal	1	8
Set	+	-
Reset	-	+

■ RECOMMENDED SOLDERING CONDITIONS FOR SMT (SEE PAGE 9) (TEMPERATURE PROFILE)

Notes:
1. Temperature profiles on page 9 show the temperature of PC board surface.
2. Please perform soldering test with your actual PC board before mass production, since the temperatures of PC board surfaces vary according to the size of PC board, status of parts mounting and heating method.

■ PRECAUTIONS

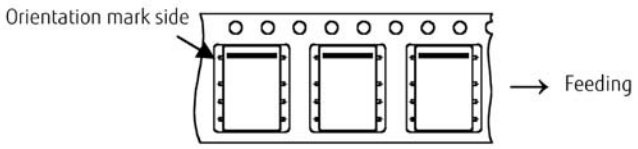
- For details on general precautions, refer to the section on technical descriptions.
- Since this is a polarized relay, follow the instructions of the internal wiring diagram for the ± connections of the coil.
- Note that the terminal layout and internal wiring of the surface mount relay are a top view.
- SMT versions of the FTR-B4 relays have moisture sensitivity level 3, acc. JEDEC-J-STD-020D
- SMT versions of the FTR-B4 relays will be shipped in "dry pack". Relays have an "out of bag" storage time of 192h.

■ PACKAGING SPECIFICATIONS

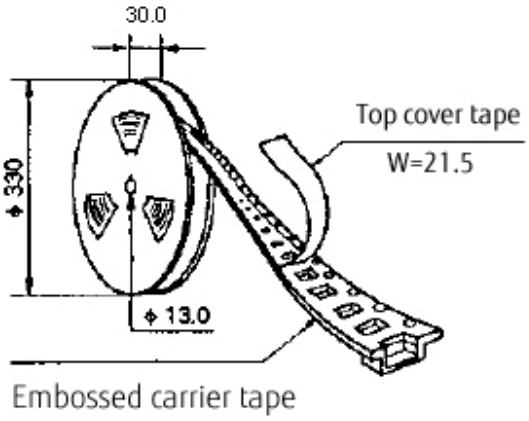
● Packaging method

- Packaging standard: JIS C 0806
- Taping type: TB 2412
- Reel type: R24D
- Quantity of 1 reel: 500 pieces

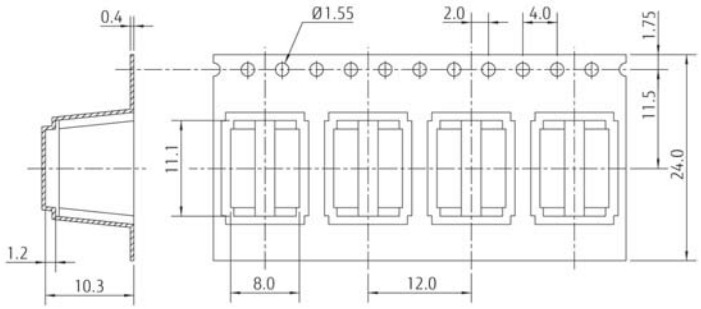
● Packaging orientation code: B



● Reel dimensions



● Tape dimensions



Note:
Relays are sold in 500 pieces per box. Minimum order quantity is 1000 pieces for tube packing and 500 pieces for tape & reel packing.

RoHS Compliance and Lead Free Information

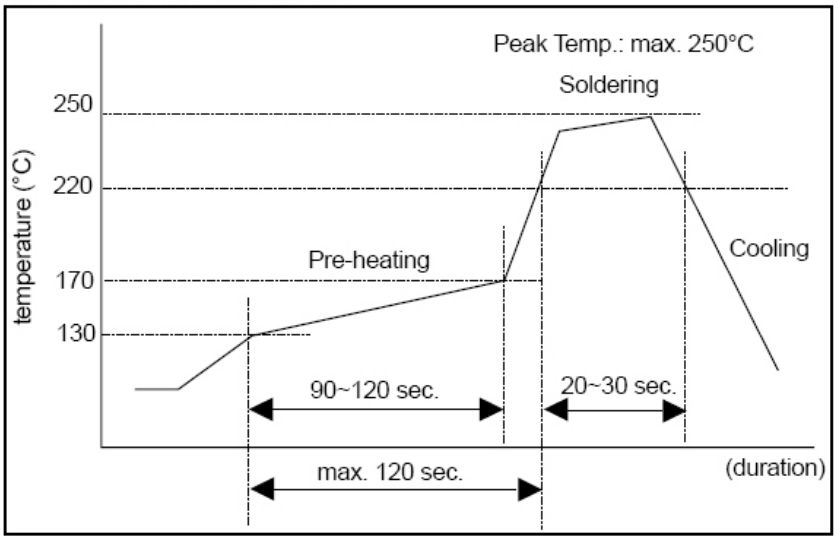
1. General Information

- All signal and power relays produced by Fujitsu Components are compliant with RoHS directive 2002/95EC including amendments.
- Cadmium as used in electrical contacts is exempted from the RoHS directives on October 21st, 2005. (Amendment to Directive 2002/95/EC)
- All of our signal and power relays are lead-free. Please refer to Lead-Free Status Info for older date codes at: http://www.fujitsu.com/us/downloads/MICRO/fcai/relays/lead-free-letter.pdf
- Lead free solder plating on relay terminals is Sn-3.0Cu-Ni for FTR-B3 and FTR-B4 series relays. This material has been verified to be compatible with PbSn assembly process.

2. Recommended Lead Free Solder Profile

- Recommended solder Sn-3.0Ag-0.5Cu or Sn-3.0 Cu-Ni (only FTR-B3 and FTR-B4)

Reflow Solder condition



Flow Solder condition:

Pre-heating:	maximum 120˚C
Soldering:	dip within 5 sec. at 260˚C solder bath

Solder by Soldering Iron:

Soldering Iron Temperature:	maximum 360˚C
Duration:	maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

- Moisture Sensitivity Level standard is not applicable to electromechanical relays, unless otherwise indicated.

4. Tin Whiskers

- Dipped SnAgCu solder is known as presenting a low risk to tin whisker development. No considerable length whisker was found by our in house test.

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